

**Features:**

- n High short circuit capability, self limiting short circuit current
- n Fast switching and short tail current
- n Low switching losses
- n 10kΩ Gate Protected Resistance Inside

Typical Applications:

- n Inverter for Motor Drive
- n High Power Converters
- n Medical applications
- n UPS systems

SYMBOL	CHARACTERISTIC	TEST CONDITIONS	VALUE			UNIT
			Min	Type	Max	
V_{CES}	Collector-Emitter voltage	$T_j=25^\circ\text{C}$			600	V
V_{GES}	Gate-Emitter voltage	$T_j=25^\circ\text{C}$			± 20	V
I_C	Collector current	$T_C=60^\circ\text{C}$			600	A
		$T_C=25^\circ\text{C}$			720	A
P_C	Collector power dissipation	$T_j=25^\circ\text{C}$, 1 device			1650	W
T_j	Junction temperature	/			175	$^\circ\text{C}$
T_{stg}	Storage temperature	/			125	$^\circ\text{C}$
V_{iso}	Isolation between terminal and copper base	$T_j=25^\circ\text{C}$, AC: 1minute			3000	V
Screw torque	Heatsink(M6)	/			5	N·m
	Terminals(M6)	/			5	N·m
	Terminals(M4)	/			1.1	N·m
I_{CES}	Zero gate voltage collector current	$T_j=25^\circ\text{C}$, $V_{CE}=600\text{V}$, $V_{GE}=0\text{V}$			1	mA
I_{GES}	Gate-Emitter leakage current	$T_j=25^\circ\text{C}$, $V_{CE}=0\text{V}$, $V_{GE}=\pm 15\text{V}$			± 0.4	μA
$V_{GE(th)}$	Gate-Emitter threshold voltage	$T_j=25^\circ\text{C}$, $V_{CE}=V_{GE}$, $I_C=9.6\text{mA}$	4.9	5.8	6.5	V
$V_{CE(sat)}$	Collector-Emitter saturation voltage	$T_j=25^\circ\text{C}$, $V_{GE}=15\text{V}$, $I_C=600\text{A}$		1.45	1.90	V
		$T_j=125^\circ\text{C}$, $V_{GE}=15\text{V}$, $I_C=600\text{A}$		1.60		V
C_{ies}	Input capacitance	$T_j=25^\circ\text{C}$, $V_{CE}=25\text{V}$, $V_{GE}=0\text{V}$, $f=1\text{MHz}$		37.2		nF
t_{on}	Turn-on time	$T_j=125^\circ\text{C}$, $V_{CC}=300\text{V}$, $I_C=100\text{A}$, $V_{GE}=\pm 15\text{V}$, $R_G=10\Omega$, Inductive load		290		ns
t_r				90		ns
t_{off}	Turn-off time			520		ns
t_f				100		ns
V_F	Forward on voltage	$T_j=25^\circ\text{C}$, $I_F=600\text{A}$		1.55	1.90	V
		$T_j=125^\circ\text{C}$, $I_F=600\text{A}$		1.50		V
Q_{rr}	Reverse recovery charge	$T_j=125^\circ\text{C}$, $I_F=600\text{A}$, $di/dt=-6800\text{A}/\mu\text{s}$, $V_R=300\text{V}$		50		μC
$R_{th(j-c)}$	Thermal resistance(1 device)	IGBT			0.09	$^\circ\text{C}/\text{W}$
Outline	452H2					

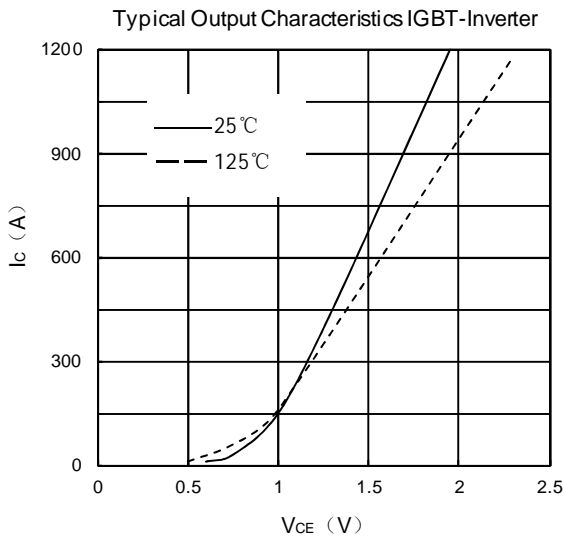


Fig1

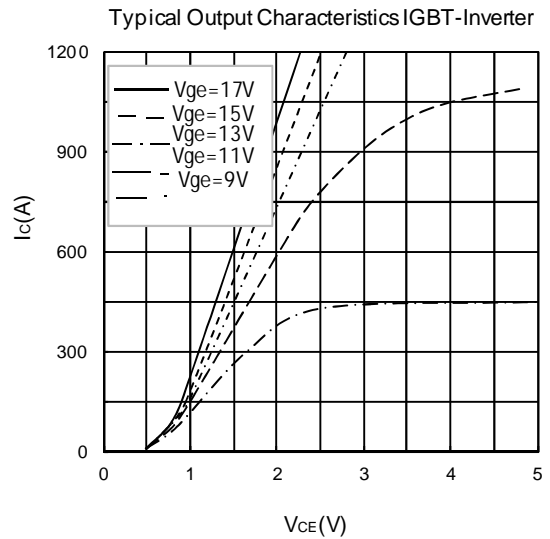


Fig2

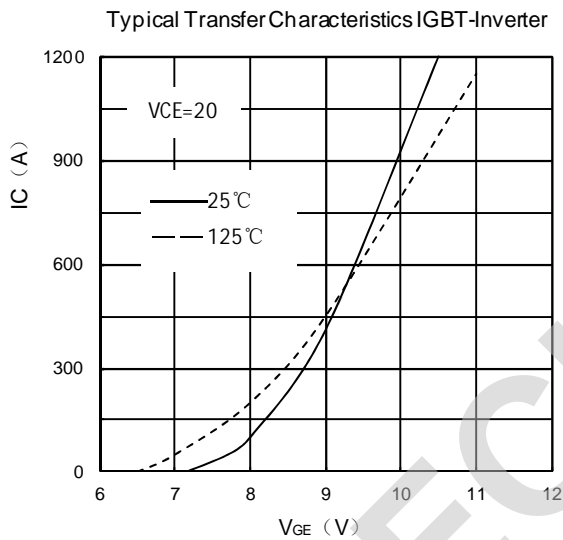


Fig3

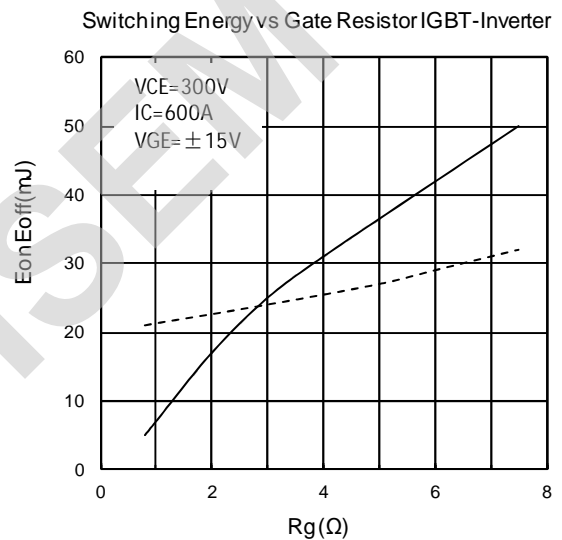


Fig4

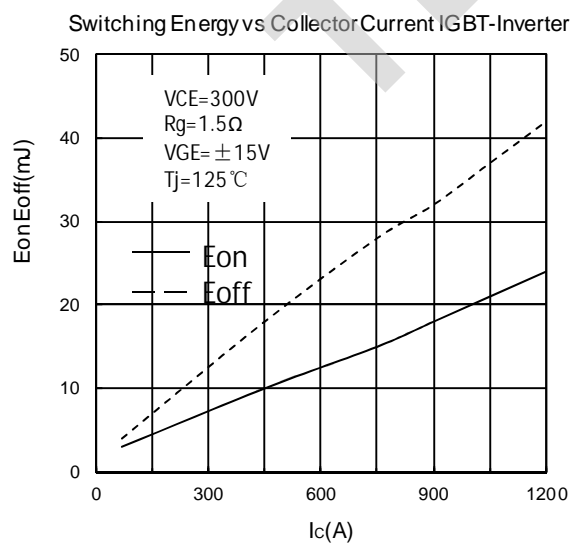


Fig5

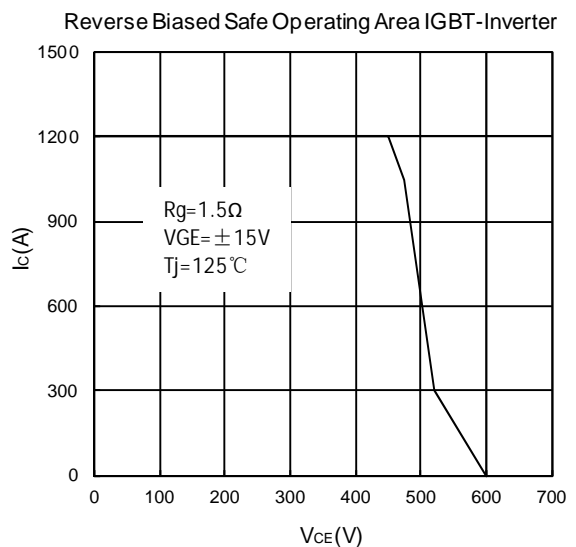


Fig6

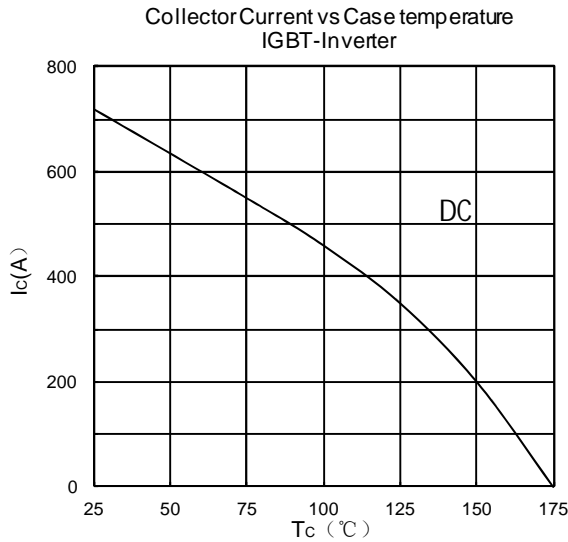


Fig7

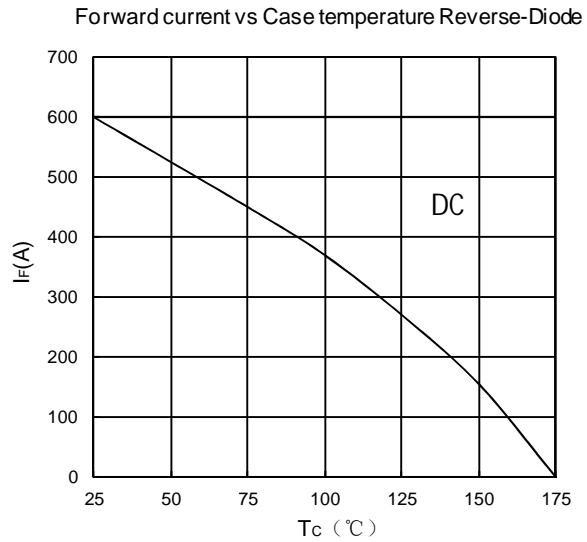


Fig8

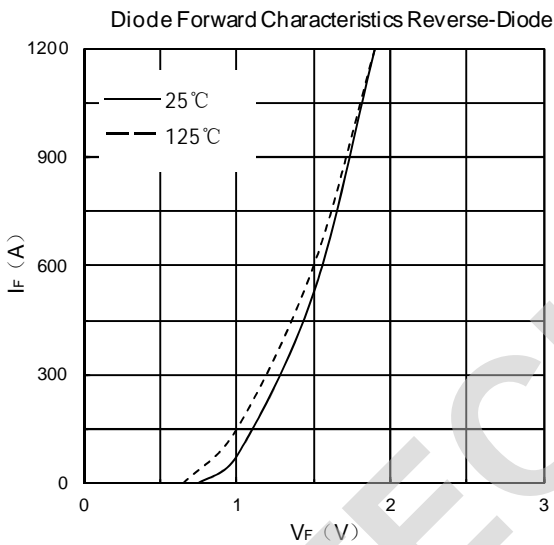


Fig9

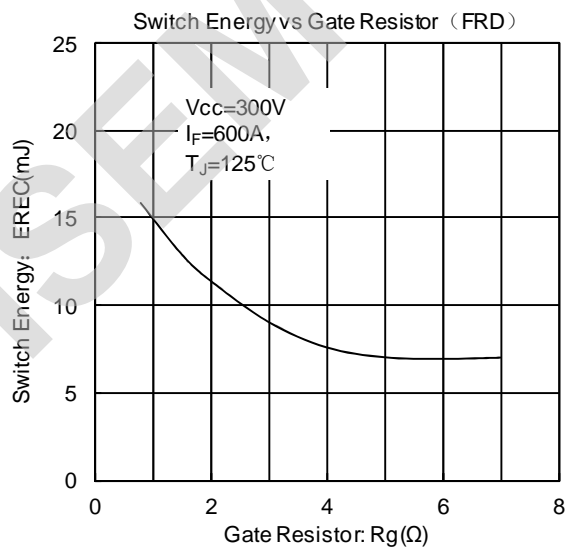


Fig10

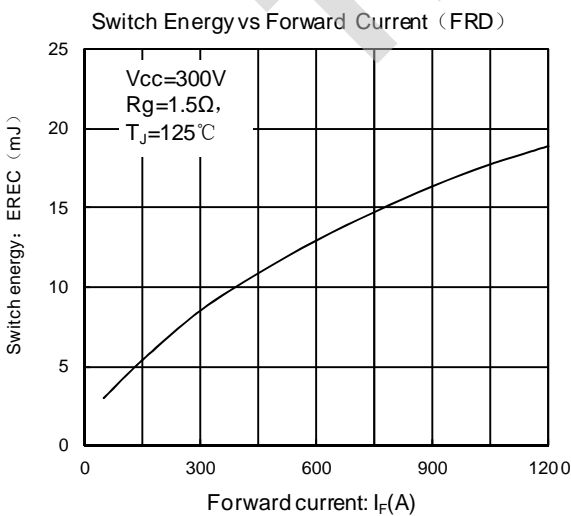


Fig11

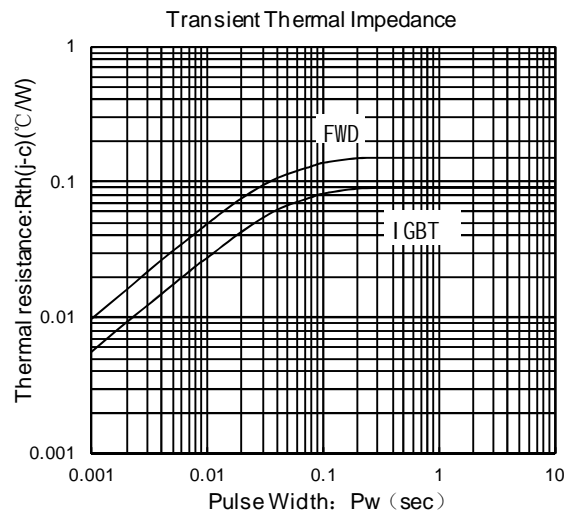
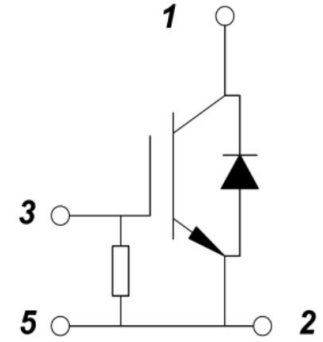
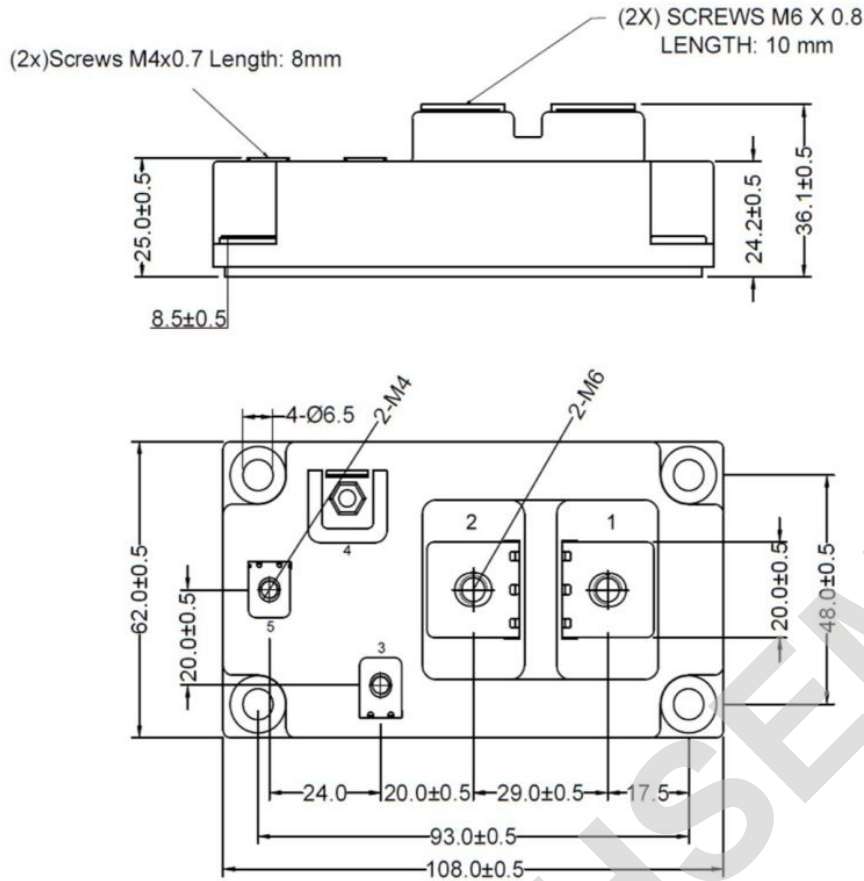


Fig12

Outline & Circuit Diagram



Unmarked dimensional tolerance: ±0.5mm

TECHSEM reserves the right to change specifications without notice.